



# Product Change Notification

**Change Notification #:** 119443-00

**Change Title:** Trusted Platform Module 2.0 AXXTPMENC8,  
PCN 119443-00, Product Design, Order Code,  
New TPM IC and Firmware Update

**Date of Publication:** February 3, 2023

## Key Characteristics of the Change:

Product Design, Order Code

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material*</b>	February 25, 2023
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is implementing the following change on the item listed in the “Products Affected” table.

Intel is upgrading the Trusted Platform Module (TPM) Integrated Circuit (IC) from version SLB9670 to SLB9672, updating its firmware version from 7.85 to 15.21.

Starting March 31st, Windows 2024 customers will need TPM SLB9672 in order to provision and certify their server systems. Previous TPM SLB9670 is still compatible with earlier Windows versions.

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Customers should take note and place future orders using the new MM number.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change MM	Post Change TA	Post Change PBA
AXXTPMENC8	AXXTPMENC8	955867	J33568-005	J33567-152	99C8ZX	N10615-001	N10412-152

## PCN Revision History:

**Date of Revision:**  
February 3, 2023

**Revision Number:**  
00

**Reason:**  
Originally Published PCN



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No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

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**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

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